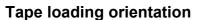


NPN/PNP Silicon Digital Transistor Array

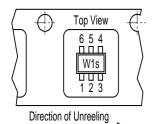
- Switching circuit, inverter, interface circuit, driver circuit
- Two (galvanic) internal isolated NPN/PNP Transistors in one package
- Built in bias resistor NPN and PNP $(R_1=10 \text{ k}\Omega, R_2=10 \text{ k}\Omega)$
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101







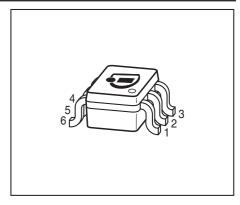
Junction - soldering point¹⁾

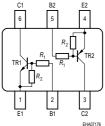


Marking on SOT-363 package (for example W1s) corresponds to pin 1 of device

Position in tape: pin 1 opposite of feed hole side

EUA0740





Туре	Marking		Pin Configuration Package					
BCR10PN	W1s	1=E1	2=B1	3=C2	4=E2	5=B2	6=C1	SOT363

Maximum Ratings for NPN and PNP Types

		Unit	
V_{CEO}	50	V	
V_{CBO}	50		
V _{i(fwd)}	40		
V _{i(rev)}	10		
I _C	100	mA	
P _{tot}	250	mW	
$T_{\rm j}$	150	°C	
T _{stg}	-65 150		
	V_{CBO} $V_{\mathrm{i(fwd)}}$ $V_{\mathrm{i(rev)}}$ I_{C} P_{tot} T_{j}	V _{CBO} 50 V _{i(fwd)} 40 V _{i(rev)} 10 I _C 100 P _{tot} 250 T _j 150	

 $^{^{1}}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

K/W

≤ 140

R_{thJS}



Electrical Characteristics at T_A =25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics for NPN and PNP Type	es				
Collector-emitter breakdown voltage	V _{(BR)CEO}	50	-	-	V
$I_{\rm C} = 100 \ \mu {\rm A}, \ I_{\rm B} = 0$					
Collector-base breakdown voltage	V _{(BR)CBO}	50	-	-	
$I_{\rm C}$ = 10 μ A, $I_{\rm E}$ = 0					
Collector cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 40 \text{ V}, I_{\rm E} = 0$					
Emitter cutoff current	I _{EBO}	-	-	0.75	mA
$V_{\rm EB}$ = 10 V, $I_{\rm C}$ = 0					
DC current gain 1)	h _{FE}	30	-	-	-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 5 V					
Collector-emitter saturation voltage1)	V _{CEsat}	-	-	0.3	V
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA					
Input off voltage	$V_{i(off)}$	8.0	-	1.5	
$I_{\rm C}$ = 100 μ A, $V_{\rm CE}$ = 5 V					
Input on Voltage	V _{i(on)}	1	-	2.5	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 0.3 V					
Input resistor	R ₁	7	10	13	kΩ
Resistor ratio	R_1/R_2	0.9	1	1.1	_
AC Characteristics for NPN and PNP Type	es				
Transition frequency	f_{T}	-	130	-	MHz
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V, f = 100 MHz					
Collector-base capacitance	C _{cb}	-	3	-	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$					

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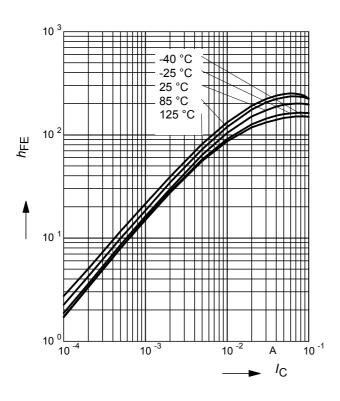
¹⁾ Pulse test: $t < 300\mu s$; D < 2%



NPN Type

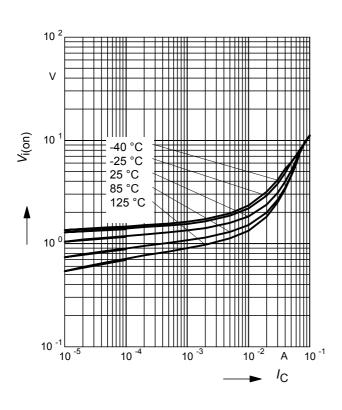
DC Current Gain $h_{FE} = f(I_C)$

 V_{CF} = 5V (common emitter configuration)



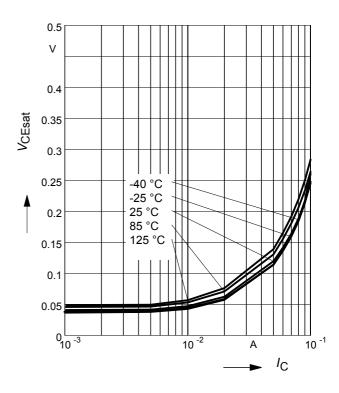
Input on Voltage $V_{i(On)} = f(I_C)$

 V_{CE} = 0.3V (common emitter configuration)



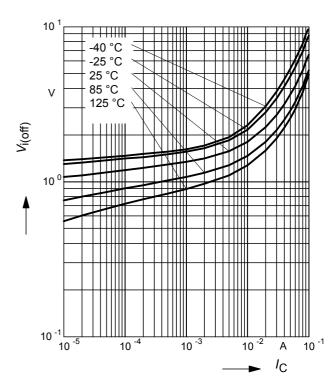
Collector-Emitter Saturation Voltage

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$



Input off voltage $V_{i(Off)} = f(I_C)$

 V_{CE} = 5V (common emitter configuration)

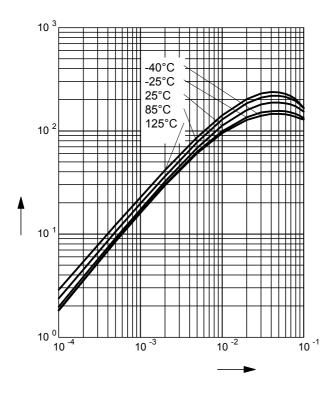




PNP Type

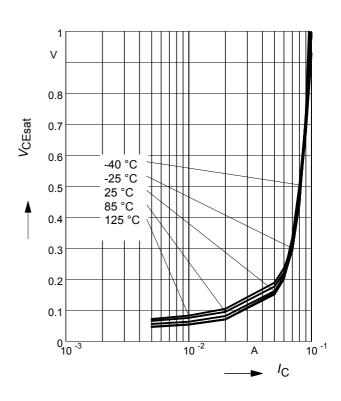
DC Current Gain $h_{FE} = f(I_C)$

 V_{CF} = 5V (common emitter configuration)



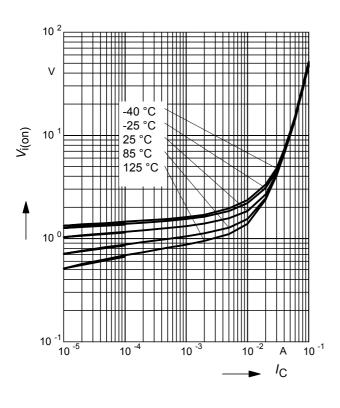
Collector-Emitter Saturation Voltage

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$



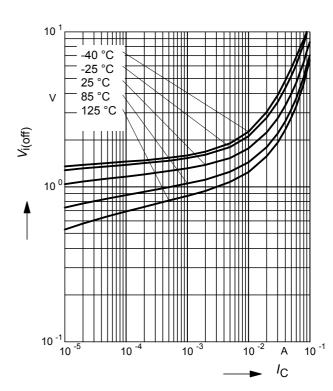
Input on Voltage $V_{i(on)} = f(I_C)$

 V_{CE} = 0.3V (common emitter configuration)



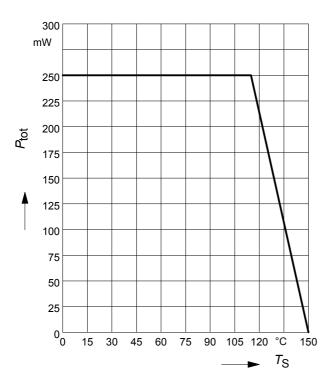
Input off voltage $V_{i(Off)} = f(I_C)$

 V_{CE} = 5V (common emitter configuration)

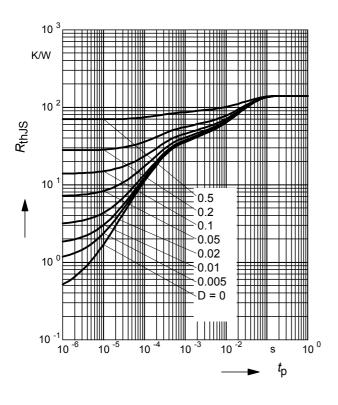




Total power dissipation $P_{tot} = f(T_S)$

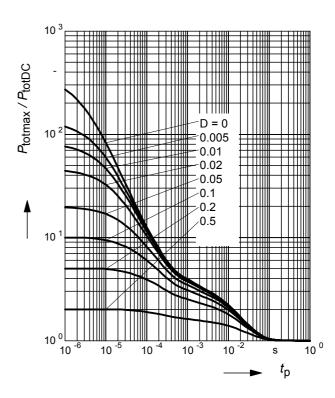


Permissible Pulse Load $R_{thJS} = f(t_p)$



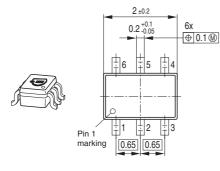
Permissible Pulse Load

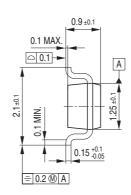
$$P_{\text{totmax}} / P_{\text{totDC}} = f(t_p)$$



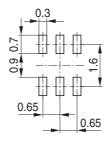


Package Outline



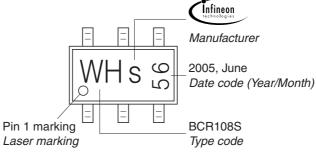


Foot Print



Marking Layout (Example)

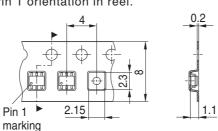
Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



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